

Abstract

An electronic device (1) has a base plate (2) and an electronics housing (3) connected thereto, with a bond contact bearer (5). The latter rests on the base plate (2) via a supporting body (6) in such a manner that the supporting body (6) exerts a pretension force onto the bond contact bearer (5). Due to the support of the bond contact bearer (5) in the close vicinity, its position is well defined during the bonding procedure. A secure bond is the result.

- Fig. 2 -

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